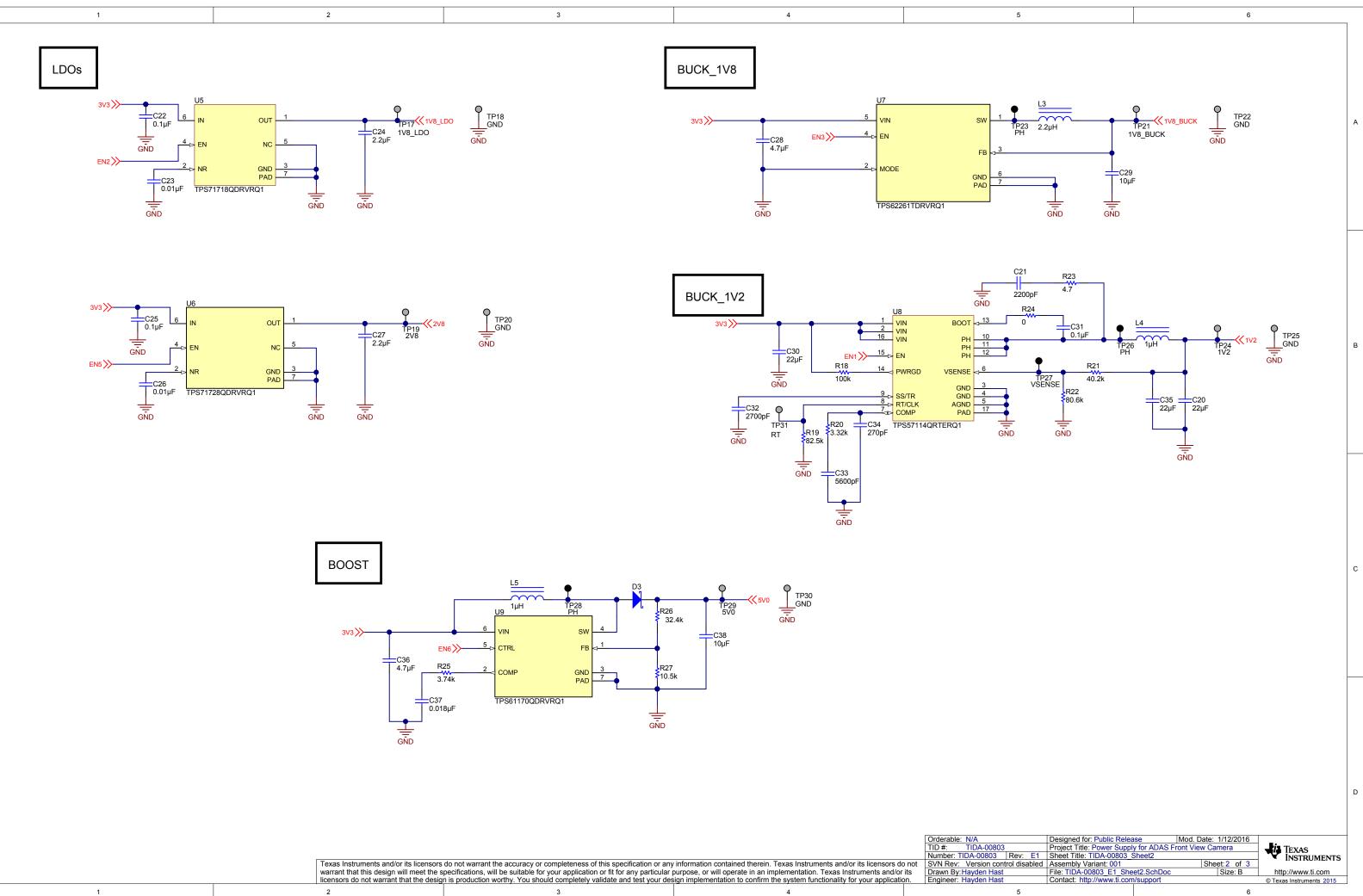
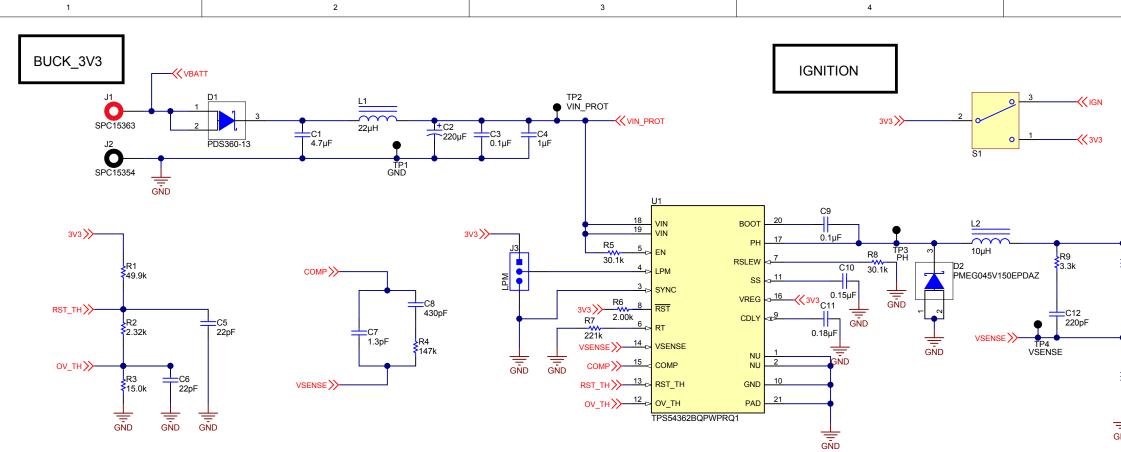


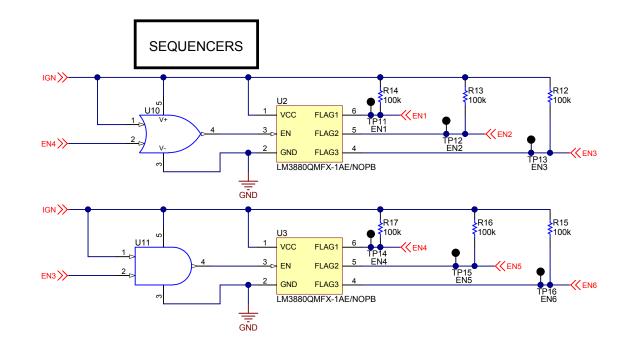
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Revision History					
Rev	ECN #	Approved Date	Approved by	Notes	
А	N/A	N/A	N/A	N/A	

	Designed for: Public Relea	se Mod. D	ate: 1/21/2016	_
03	Project Title: Power Supply	y for ADAS Front View	v Camera	JIA TEXAS
Rev: E1 Sheet Title: TIDA-00803 C		CoverSheet		TEXAS INSTRUMENTS
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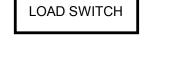


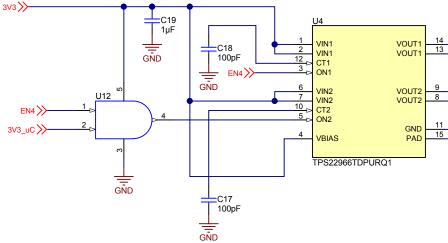
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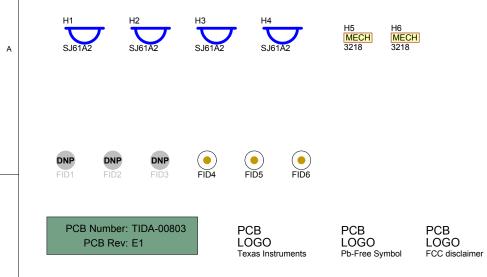




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_3≪IGN _1≪3∨3		_MAIN TP6		A
PDAZ PDAZ R9 3.3k C12 220pF TP4 VSENSE R10 147k G R10 F G G	C13 0.1µF ND GND			В
VOUT1 VOUT2 VOUT2 9 VOUT2 8 GND PAD 15 F TDPURQ1	C15 3V3_uC 0.1µF GND C16 3V3_uC 0.1µF GND C16 3V3_uP 0.1µF 0.1µF 0.1µF	TP8 GND GND TP10 GND GND		C
Orderable: N/A GND TID #: TIDA-00803 Number: TIDA-00803 Number: TIDA-00803 Rev: E1 SVN Rev: Version control disabled Drawn By: Hayden Hast Engineer: Hayden Hast	Designed for: Public Relac	ase Mod. Date: 1/11/2016 y for ADAS Front View Camera Sheet1 Sheet: 2 of 3 et1.SchDoc Size: B /support	TEXAS INSTRUMENTS http://www.ti.com © Texas Instruments 2015	D

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1	2	3	4	



Label Table			
Variant	Label Text		
001	TIDA-00803		

В

С

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ZZ1 Assembly Note Place washers H5 & H6 over threaded studs of banana jacks J1 & J2 before assembling onto board to increase clearance below them.

ZZ2 Assembly Note These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

1

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable:		
TID #:	TIDA-0	
Number: TI	DA-008	03
SVN Rev:	Versio	n con
Drawn By:		
Engineer:	layden	Hast

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licensors do not warrant that the desig	n is production worthy. You should completely validate and test your des	sign implementation to confirm the system functionality for your application	on. Engi
2	2	4	
2	5	4	1

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 Designed for: Public Release
 Mod. Date:
 1/20/2016

 03
 Project Title: Power Supply for ADAS Front View Camera

 Rev:
 E1
 Sheet Title: TIDA-00803 Hardware

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 Assembly Variant: 001
 Sheet: 3 of 3

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